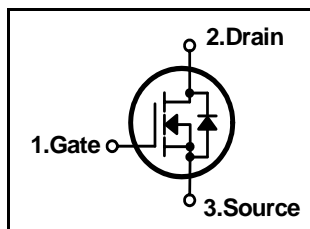


## N-Channel MOSFET

### Features

- Low  $R_{DS(on)}$  ( $0.012\Omega$ ) @  $V_{GS}=10V$
- Low Gate Charge (Typical 90nC)
- Low  $C_{rss}$  (Typical 215pF)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Maximum Junction Temperature Range



$$BV_{DSS} = 75V$$

$$R_{DS(ON)} = 0.012 \text{ ohm}$$

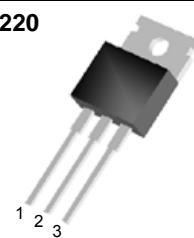
$$I_D = 80A$$

### General Description

This N-channel enhancement mode field-effect power transistor using DI semiconductor's advanced planar stripe, DMOS technology intended for battery operated systems like a DC-DC converter motor control, ups, audio amplifier.

Also, especially designed to minimize  $r_{ds(on)}$ , low gate charge and high rugged avalanche characteristics.

TO-220



### Absolute Maximum Ratings

| Symbol         | Parameter  | Value      | Units         |
|----------------|--|------------|---------------|
| $V_{DSS}$      | Drain to Source Voltage  | 75         | V             |
| $I_D$          | Continuous Drain Current(@ $T_C = 25^\circ C$ )                              | 80         | A             |
|                | Continuous Drain Current(@ $T_C = 100^\circ C$ )                             | 46         | A             |
| $I_{DM}$       | Drain Current Pulsed (Note 1)  | 320        | A             |
| $V_{GS}$       | Gate to Source Voltage   | $\pm 20$   | V             |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                                      | 1350       | mJ            |
| dv/dt          | Peak Diode Recovery dv/dt (Note 3)   | 7.0        | V/ns          |
| $P_D$          | Total Power Dissipation(@ $T_C = 25^\circ C$ )                               | 176        | W             |
|                | Derating Factor above $25^\circ C$   | 1.05       | W/ $^\circ C$ |
| $T_{STG}, T_J$ | Operating Junction Temperature & Storage Temperature                         | - 55 ~ 175 | $^\circ C$    |
| $T_L$          | Maximum Lead Temperature for soldering purpose, 1/8 from Case for 5 seconds. | 300        | $^\circ C$    |

### Thermal Characteristics

| Symbol          | Parameter                               | Value |      |      | Units        |
|-----------------|---|-------|------|------|--------------|
|                 |   | Min.  | Typ. | Max. |              |
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case    | -     | -    | 0.85 | $^\circ C/W$ |
| $R_{\theta CS}$ | Thermal Resistance, Case to Sink        | -     | 0.5  | -    | $^\circ C/W$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | -     | -    | 62.5 | $^\circ C/W$ |

# DFP75N75

## Electrical Characteristics (T<sub>C</sub> = 25 °C unless otherwise noted)

| Symbol                               | Parameter                                 | Test Conditions   | Min | Typ   | Max   | Units |
|--------------------------------------|---|---|-----|-------|-------|-------|
| <b>Off Characteristics</b>           |   |   |     |       |       |       |
| BV <sub>DSS</sub>                    | Drain-Source Breakdown Voltage            | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA  | 75  | -     | -     | V     |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature coefficient | I <sub>D</sub> = 250uA, referenced to 25 °C   | -   | 0.066 | -     | V/°C  |
| I <sub>DSS</sub>                     | Zero Gate Voltage Drain Current           | V <sub>DS</sub> = 75V, V <sub>GS</sub> = 0V   | -   | -     | 1     | uA    |
|                                      |   | V <sub>DS</sub> = 60V, T <sub>C</sub> = 150 °C  | -   | -     | 10    | uA    |
| I <sub>GSS</sub>                     | Gate-Source Leakage, Forward              | V <sub>GS</sub> = 20V, V <sub>DS</sub> = 0V   | -   | -     | 100   | nA    |
|                                      | Gate-Source Leakage, Reverse              | V <sub>GS</sub> = -20V, V <sub>DS</sub> = 0V  | -   | -     | -100  | nA    |
| <b>On Characteristics</b>            |   |   |     |       |       |       |
| V <sub>GS(th)</sub>                  | Gate Threshold Voltage                    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250uA  | 2.0 | -     | 4.0   | V     |
| R <sub>DS(ON)</sub>                  | Static Drain-Source On-state Resistance   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40A  | -   | -     | 0.012 | Ω     |
| <b>Dynamic Characteristics</b>       |   |   |     |       |       |       |
| C <sub>iss</sub>                     | Input Capacitance                         | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25V, f = 1MHz  | -   | 3420  | 4250  | pF    |
| C <sub>oss</sub>                     | Output Capacitance                        |   | -   | 1320  | 1650  |       |
| C <sub>rss</sub>                     | Reverse Transfer Capacitance              |   | -   | 215   | 340   |       |
| <b>Dynamic Characteristics</b>       |   |   |     |       |       |       |
| t <sub>d(on)</sub>                   | Turn-on Delay Time                        | V <sub>DD</sub> = 37.5V, I <sub>D</sub> = 40A, R <sub>G</sub> = 50Ω<br>* see fig. 13. (Note 4, 5) | -   | 60    | 120   | ns    |
| t <sub>r</sub>                       | Rise Time                                 |   | -   | 70    | 160   |       |
| t <sub>d(off)</sub>                  | Turn-off Delay Time                       |   | -   | 195   | 310   |       |
| t <sub>f</sub>                       | Fall Time                                 |   | -   | 120   | 260   |       |
| Q <sub>g</sub>                       | Total Gate Charge                         | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 75A<br>* see fig. 12. (Note 4, 5)  | -   | 90    | 110   | nC    |
| Q <sub>gs</sub>                      | Gate-Source Charge                        |   | -   | 20    | -     |       |
| Q <sub>gd</sub>                      | Gate-Drain Charge(Miller Charge)          |   | -   | 33    | -     |       |

## Source-Drain Diode Ratings and Characteristics

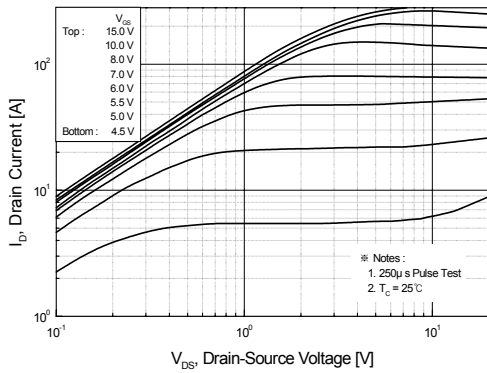
| Symbol          | Parameter                 | Test Conditions   | Min. | Typ. | Max. | Unit. |
|-----------------|---------------------------|---|------|------|------|-------|
| I <sub>S</sub>  | Continuous Source Current | Integral Reverse p-n Junction Diode in the MOSFET                         | -    | -    | 80   | A     |
| I <sub>SM</sub> | Pulsed Source Current     |   | -    | -    | 320  |       |
| V <sub>SD</sub> | Diode Forward Voltage     | I <sub>S</sub> = 80A, V <sub>GS</sub> = 0V                                | -    | -    | 1.5  | V     |
| t <sub>rr</sub> | Reverse Recovery Time     | I <sub>S</sub> = 80A, V <sub>GS</sub> = 0V, di <sub>F</sub> /dt = 100A/us | -    | 92   | -    | ns    |
| Q <sub>rr</sub> | Reverse Recovery Charge   |   | -    | 160  | -    | nC    |

### \* NOTES

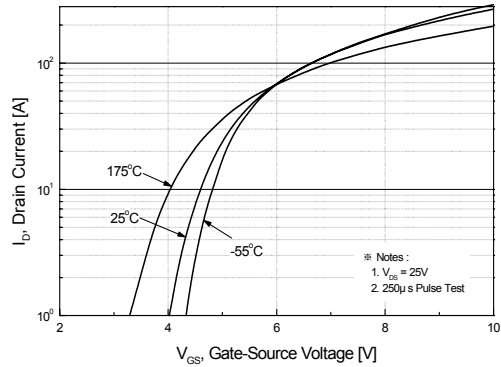
1. Repeativity rating : pulse width limited by junction temperature
2. L = 320 uH, I<sub>AS</sub> = 80A, V<sub>DD</sub> = 25V, R<sub>G</sub> = 0Ω, Starting T<sub>J</sub> = 25°C
3. ISD ≤ 80A, di/dt ≤ 300A/us, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
4. Pulse Test : Pulse Width ≤ 300us, Duty Cycle ≤ 2%
5. Essentially independent of operating temperature.

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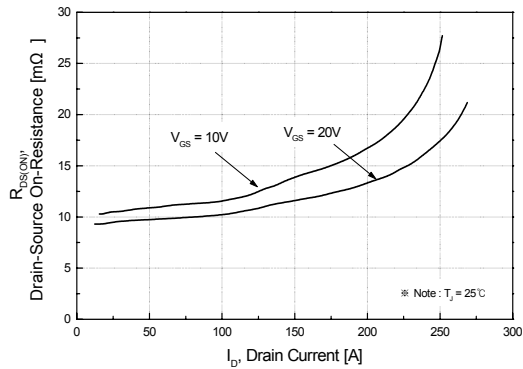
**Fig 1. On-State Characteristics**



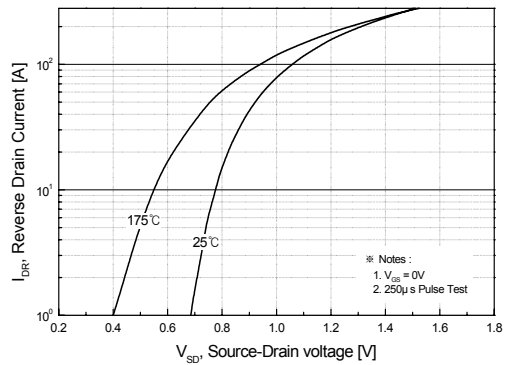
**Fig 2. Transfer Characteristics**



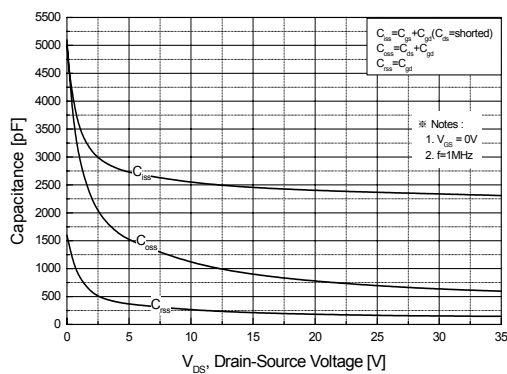
**Fig 3. On Resistance Variation vs. Drain Current and Gate Voltage**



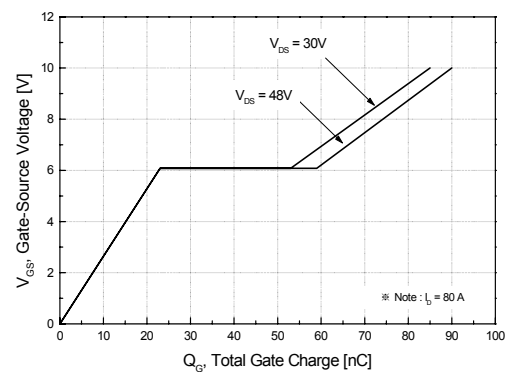
**Fig 4. On State Current vs. Allowable Case Temperature**



**Fig 5. Capacitance Characteristics**

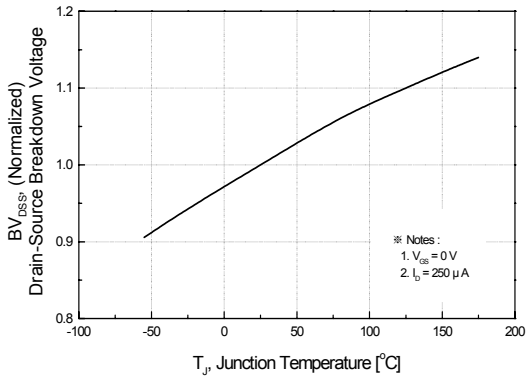


**Fig 6. Gate Charge Characteristics**

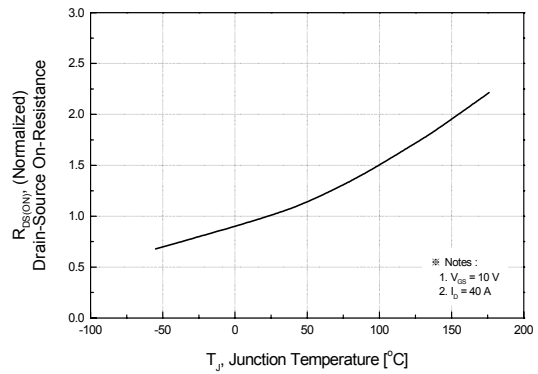


# DFP75N75

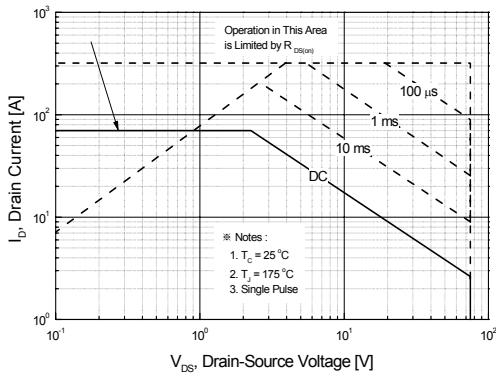
**Fig 7. Breakdown Voltage Variation vs. Junction Temperature**



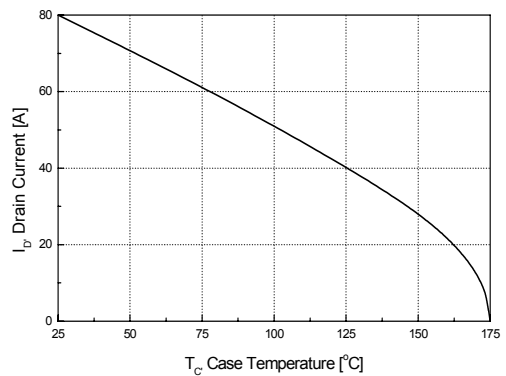
**Fig 8. On-Resistance Variation vs. Junction Temperature**



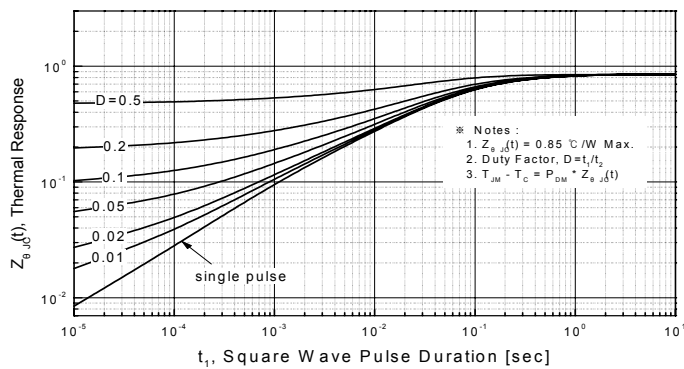
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Maximum Drain Current vs. Case Temperature**



**Fig 11. Transient Thermal Response Curve**



# DFP75N75

Fig. 12. Gate Charge Test Circuit & Waveforms

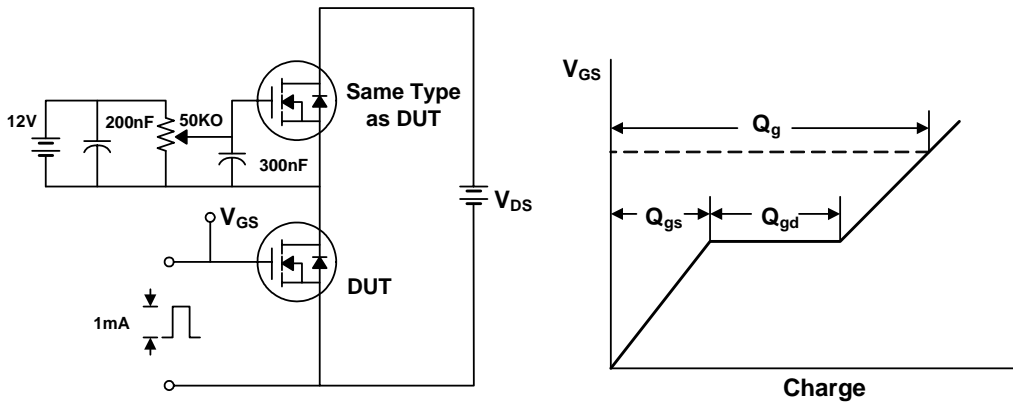


Fig 13. Switching Time Test Circuit & Waveforms

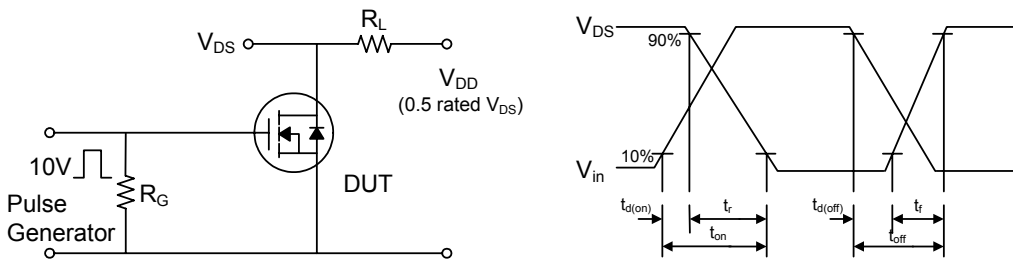
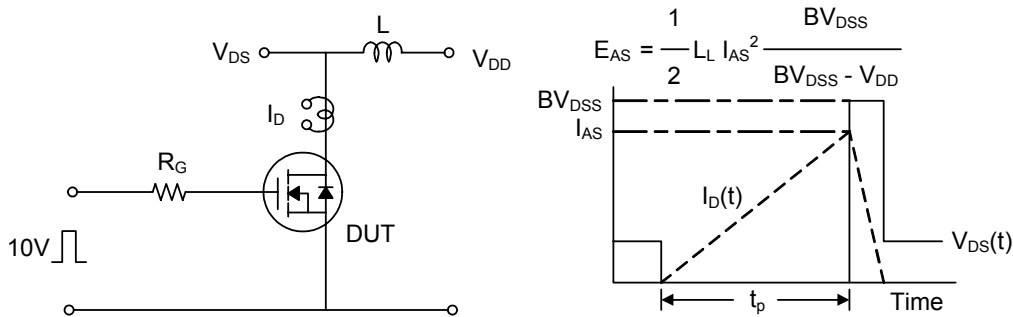
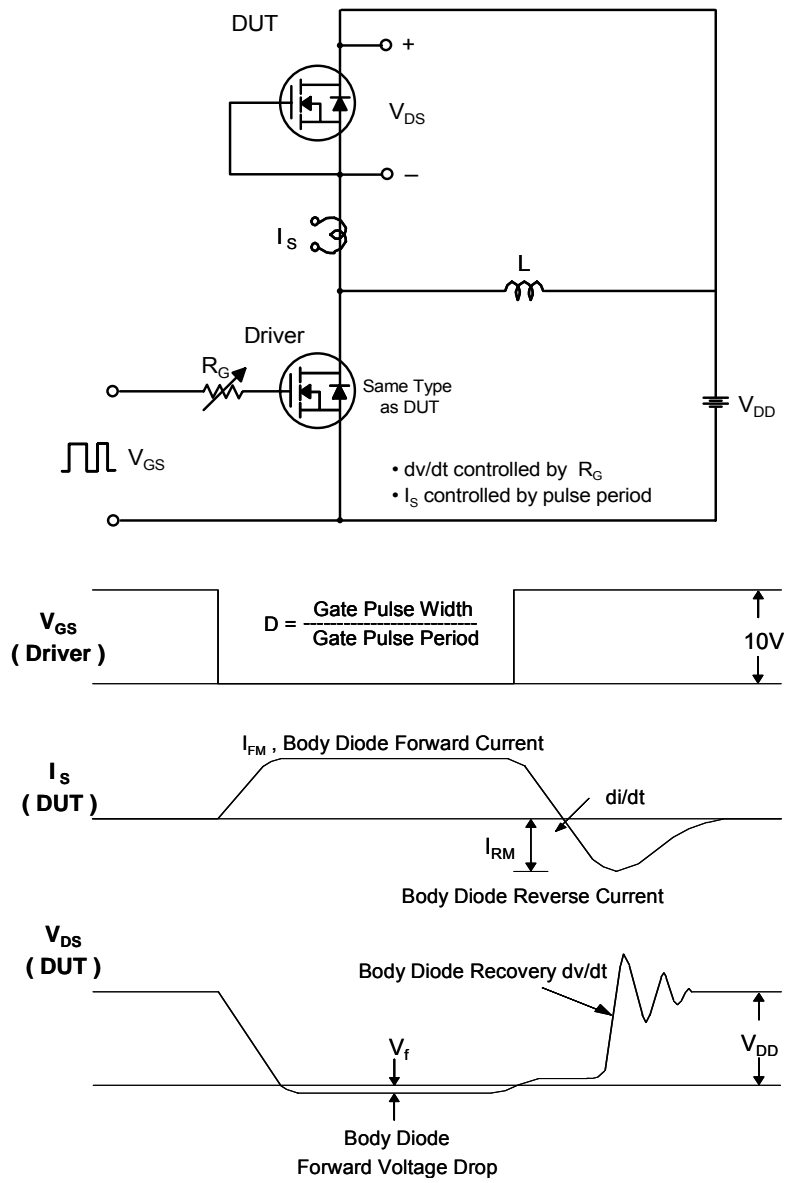


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



# DFP75N75

Fig. 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



## DFP75N75

## TO-220 Package Dimension

| Dim.   | mm    |       |       | Inch  |       |       |
|--------|-------|-------|-------|-------|-------|-------|
|        | Min.  | Typ.  | Max.  | Min.  | Typ.  | Max.  |
| A      | 6.12  | 6.32  | 6.52  | 0.241 | 0.249 | 0.257 |
| B      | 9.00  | 9.20  | 9.40  | 0.354 | 0.362 | 0.370 |
| C      | 12.88 | 13.08 | 13.28 | 0.507 | 0.515 | 0.523 |
| D      | 2.70  | 2.80  | 2.90  | 0.106 | 0.110 | 0.114 |
| E      | 1.20  | 1.30  | 1.40  | 0.047 | 0.051 | 0.055 |
| F      | 15.12 | 15.52 | 15.92 | 0.595 | 0.611 | 0.627 |
| G      | 2.70  | 3.00  | 3.30  | 0.106 | 0.118 | 0.130 |
| H      | 4.30  | 4.50  | 4.70  | 0.169 | 0.177 | 0.185 |
| I      | 1.25  | 1.30  | 1.40  | 0.049 | 0.051 | 0.055 |
| J      | 0.45  | 0.50  | 0.60  | 0.018 | 0.020 | 0.024 |
| K      | 2.30  | 2.40  | 2.50  | 0.091 | 0.094 | 0.098 |
| L      |       | 9.90  |       |       | 0.390 |       |
| M      | 1.42  | 1.52  | 1.62  | 0.056 | 0.060 | 0.064 |
| N      | 0.75  | 0.85  | 0.95  | 0.030 | 0.033 | 0.037 |
| O      | 2.44  | 2.54  | 2.64  | 0.096 | 0.100 | 0.104 |
| P      | 4.88  | 5.08  | 5.28  | 0.192 | 0.200 | 0.208 |
| $\phi$ |       | 3.60  |       |       | 0.142 |       |

